

Description

The PSM8N06R3 uses split gate trench technology to provide excellent $R_{DS(ON)}$ low gate charge. This device is suitable for power management and high efficiency applications at high switching frequencies applications.

| MOSFET Product Summary | | | |
|------------------------|-----------------------|-----------------------------------|-----|
| $V_{DS}(V)$ | $R_{DS(on)}(m\Omega)$ | $I_D(A)$ | |
| 60 | 2.5@ $V_{GS} = 10V$ | Silicon Limited $T_C=25^\circ C$ | 158 |
| | | Silicon Limited $T_C=100^\circ C$ | 100 |
| | | Package Limited $T_C=25^\circ C$ | 100 |

Feature

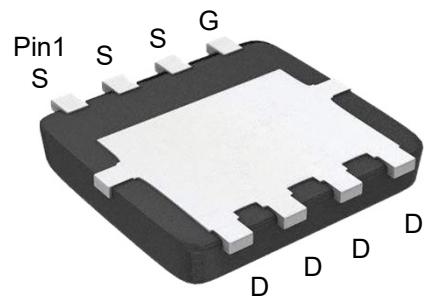
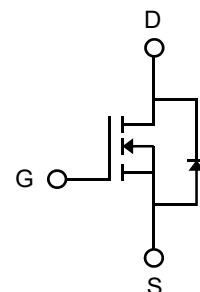
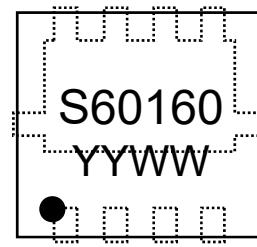
- Low $R_{DS(ON)}$ - Ensures On-State Losses are Minimized
- Excellent $Q_{gd} \times R_{DS(ON)}$ Product(FOM)
- Advanced Technology for DC-DC Converts
- Small Form Factor Thermally Efficient Package
Enables Higher Density End Products
- 100% UIS (Avalanche) Rated
- Lead-Free Finish ; RoHS Compliant
- Halogen and Antimony Free. "Green" Device

Applications

- PWM applications
- Load switch
- Power management
- DC-DC Converters
- Wireless Chargers

Absolute maximum rating@25°C

| Rating | | Symbol | Value | Units |
|---|-----------------------------------|-----------------|----------|-------|
| Drain-Source Voltage | | V_{DS} | 60 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | V |
| Drain Current-Continuous | Silicon Limited $T_C=25^\circ C$ | I_D | 158 | A |
| | Silicon Limited $T_C=100^\circ C$ | | 100 | |
| | Package Limited $T_C=25^\circ C$ | | 100 | |
| Pulsed Drain Current ¹⁾ | | I_{DM} | 380 | A |
| Total Power Dissipation ²⁾ | | P_D | 92 | W |
| Avalanche Current ⁵⁾ | | I_{AS} | 75.5 | A |
| Avalanche Energy ⁵⁾ | | E_{AS} | 285 | mJ |
| Thermal Resistance , Junction-case | | $R_{\theta JC}$ | 1.36 | °C/W |
| Thermal Resistance Junction-to-Ambient @ Steady State ²⁾ | | $R_{\theta JA}$ | 43.65 | °C/W |
| Junction and Storage Temperature Range | | T_J, T_{STG} | -55~+150 | °C |


Bottom View

Circuit Diagram

Marking (Top View)

N-Channel MOSFET

PSM8N06R3

Electrical characteristics per line@25°C (unless otherwise specified)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Units |
|-------------------------------------|--------------|---|------|-------|-----------|-----------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS} = 0V, I_D = 250\mu A$ | 60 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 60V, V_{GS} = 0V$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS} = \pm 20V, V_{DS} = 0V$ | - | - | ± 100 | nA |
| On Characteristics ³⁾ | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 1.0 | 1.5 | 2.0 | V |
| Static Drain-Source On-Resistance | $R_{DS(ON)}$ | $V_{GS} = 10V, I_D = 20A$ | - | 2.5 | 3.5 | $m\Omega$ |
| | | $V_{GS} = 4.5V, I_D = 20A$ | - | 3.5 | 4.5 | |
| Dynamic Parameters ⁴⁾ | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS} = 30V, V_{GS} = 0V, f = 1MHz$ | - | 3122 | - | pF |
| Output Capacitance | C_{oss} | | - | 888 | - | |
| Reverse Transfer Capacitance | C_{rss} | | - | 36 | - | |
| Switching Parameters ⁴⁾ | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DS} = 30V, V_{GS} = 10V, R_G = 10\Omega, I_D = 20A$ | - | 8.7 | - | ns |
| Turn-on Rise Time | t_r | | - | 14.5 | - | |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 109.2 | - | |
| Turn-Off Fall Time | t_f | | - | 46.5 | - | |
| Total Gate Charge | Q_g | $V_{DS} = 30V, I_D = 20A, V_{GS} = 10V$ | - | 54.2 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 6.7 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 8.9 | - | |
| Gate Resistance | R_g | $V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$ | - | 1.36 | - | Ω |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ³⁾ | V_{SD} | $V_{GS} = 0V, I_S = 20A$ | - | 0.83 | 1.1 | V |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production.
5. This single-pulse measurement was taken under the following condition ($L=100\mu H, V_{GS}=10V, V_{DS}=50V$) while its value is limited by $T_{J_Max}=150^{\circ}C$.

Typical Characteristics

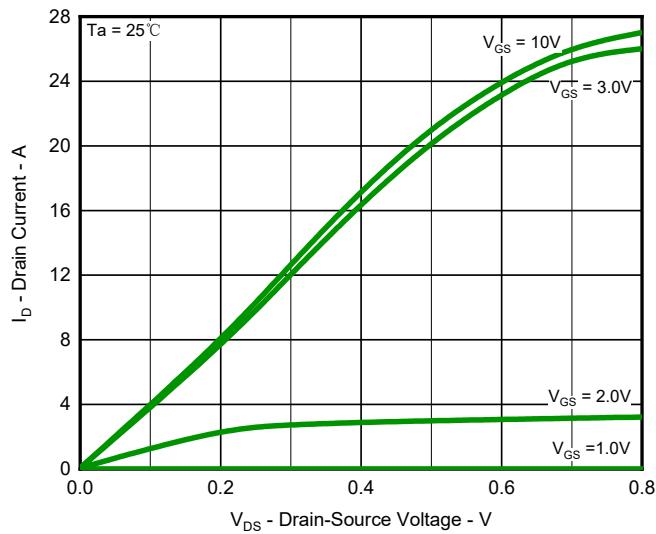


Fig.1 Output Characteristics

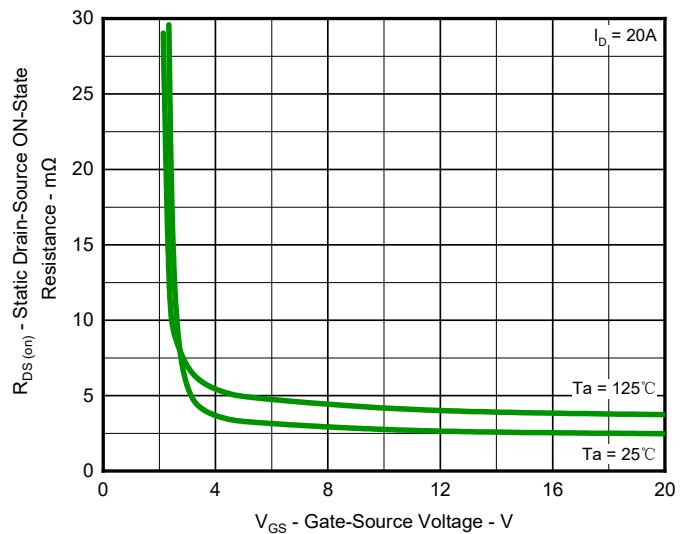


Fig.2 On-Resistance vs. Gate-Source Voltage

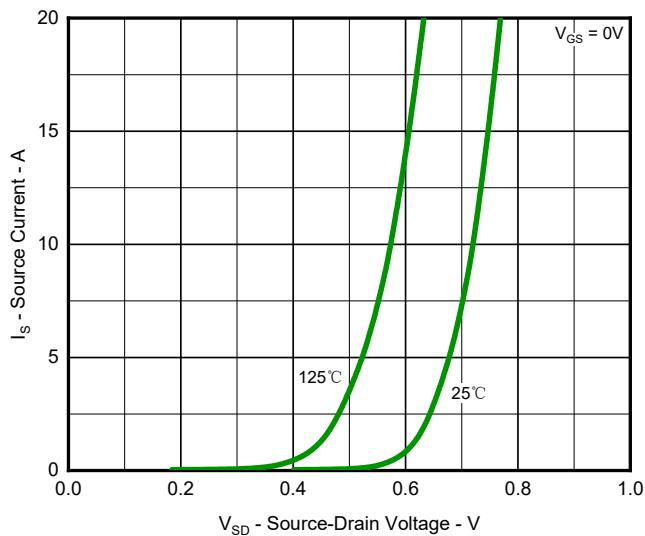


Fig.3 Diode Forward Voltage vs. Current

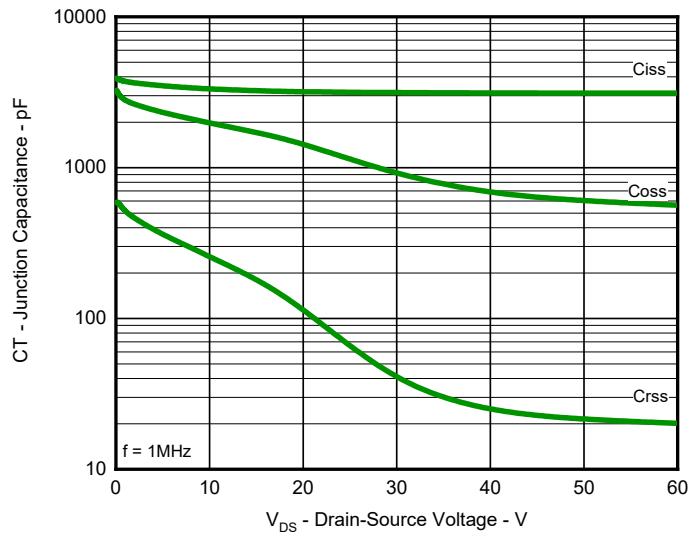


Fig.4 Typical Junction Capacitance

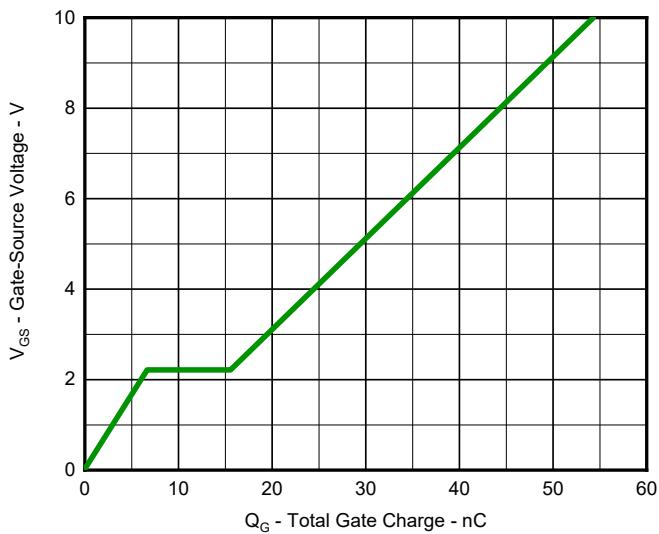


Fig.5 Gate Charge Characteristics

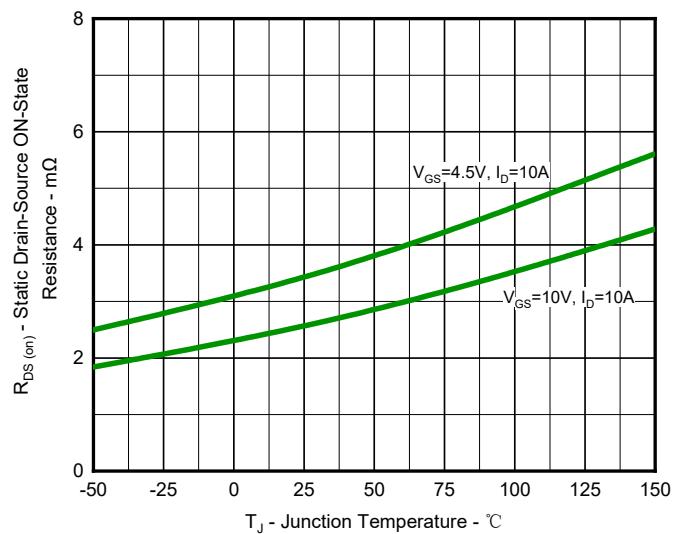


Fig.6 On-Resistance Variation with Temperature

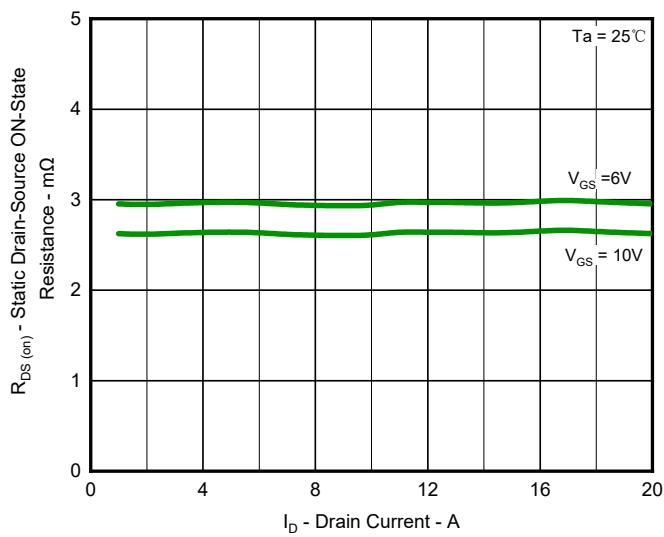


Fig.7 Typical On-Resistance vs Drain Current

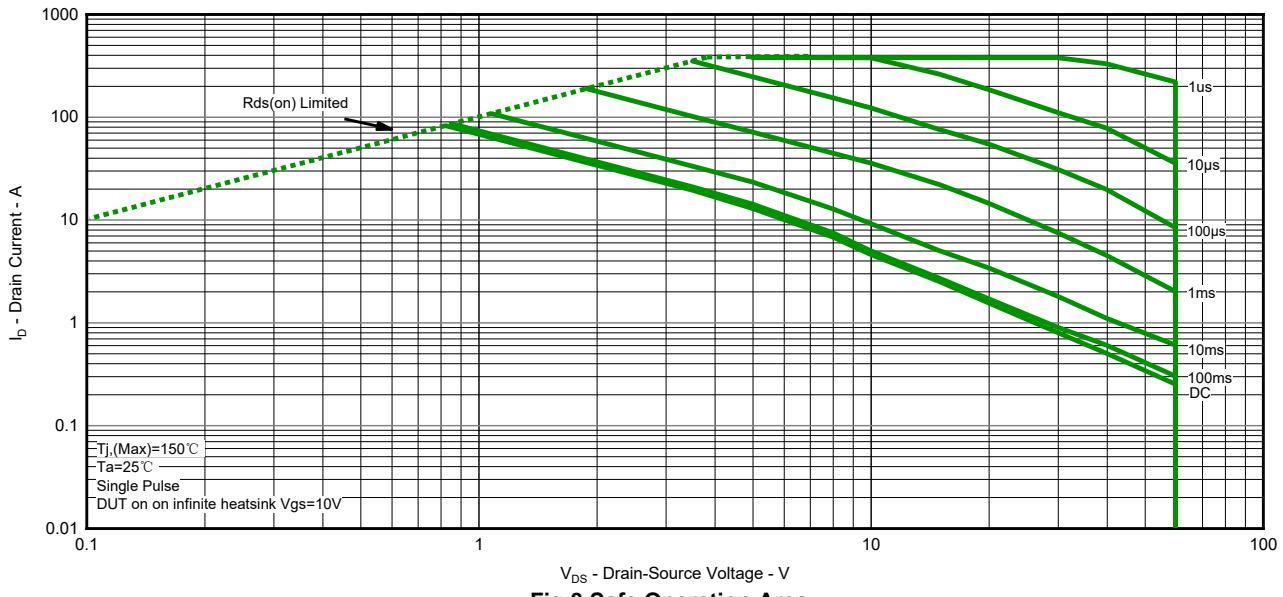


Fig.8 Safe Operation Area

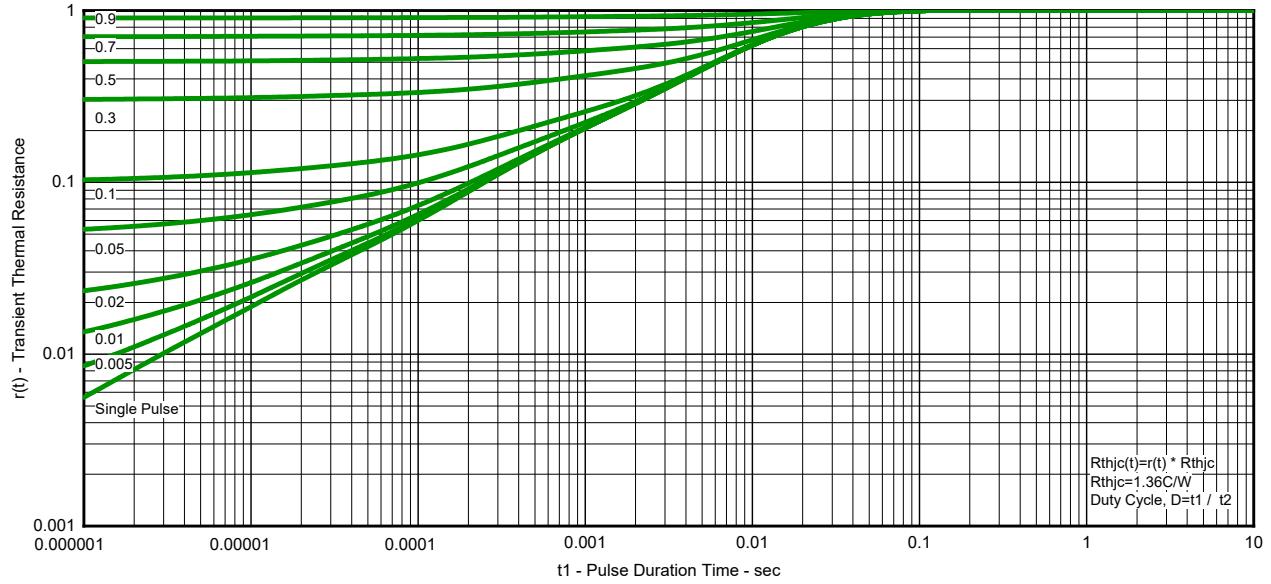
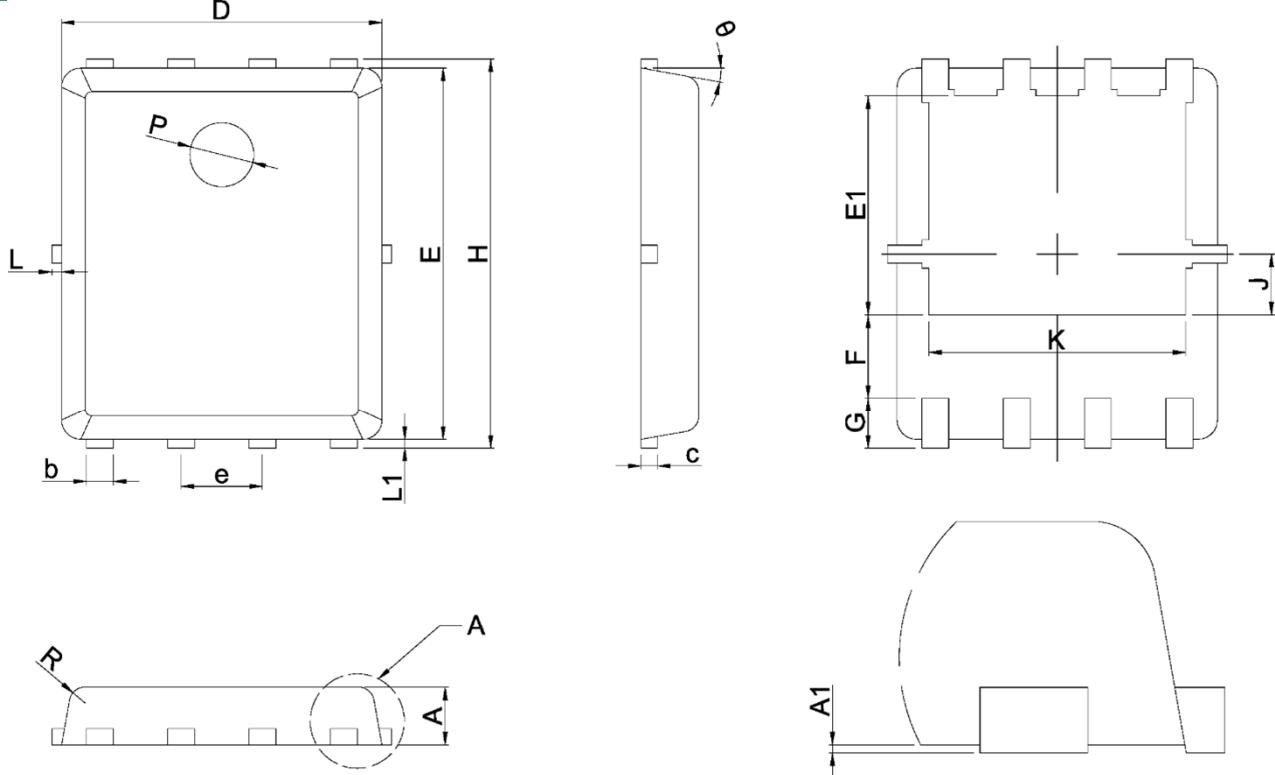


Fig.9 Transient Thermal Resistance

Product Dimension (PDFN5060-8L)



DETAIL "A"

| Dim | Millimeters | | Inches | |
|-----|-------------|------|------------|-------|
| | Min | Max | Min | Max |
| A | 0.80 | 1.00 | 0.031 | 0.039 |
| A1 | 0.00 | 0.05 | 0.000 | 0.002 |
| b | 0.35 | 0.49 | 0.014 | 0.019 |
| c | 0.254 Ref. | | 0.010 Ref. | |
| D | 4.90 | 5.10 | 0.193 | 0.201 |
| E | 5.70 | 5.90 | 0.224 | 0.232 |
| E1 | 3.35 | 3.65 | 0.132 | 0.144 |
| e | 1.27 BSC. | | 0.050 BSC. | |
| F | 1.40 Ref. | | 0.055 Ref. | |
| G | 0.60 Ref. | | 0.024 Ref. | |
| H | 5.95 | 6.20 | 0.234 | 0.244 |
| J | 0.95 BSC. | | 0.037 BSC. | |
| K | 4.00 Ref. | | 0.157 Ref. | |
| L | - | 0.15 | - | 0.006 |
| L1 | 0.10 | 0.18 | 0.004 | 0.007 |
| P | 1.00 Ref. | | 0.039 Ref. | |
| R | 0.25 Ref. | | 0.010 Ref. | |
| θ | 6° | 14° | 6° | 14° |

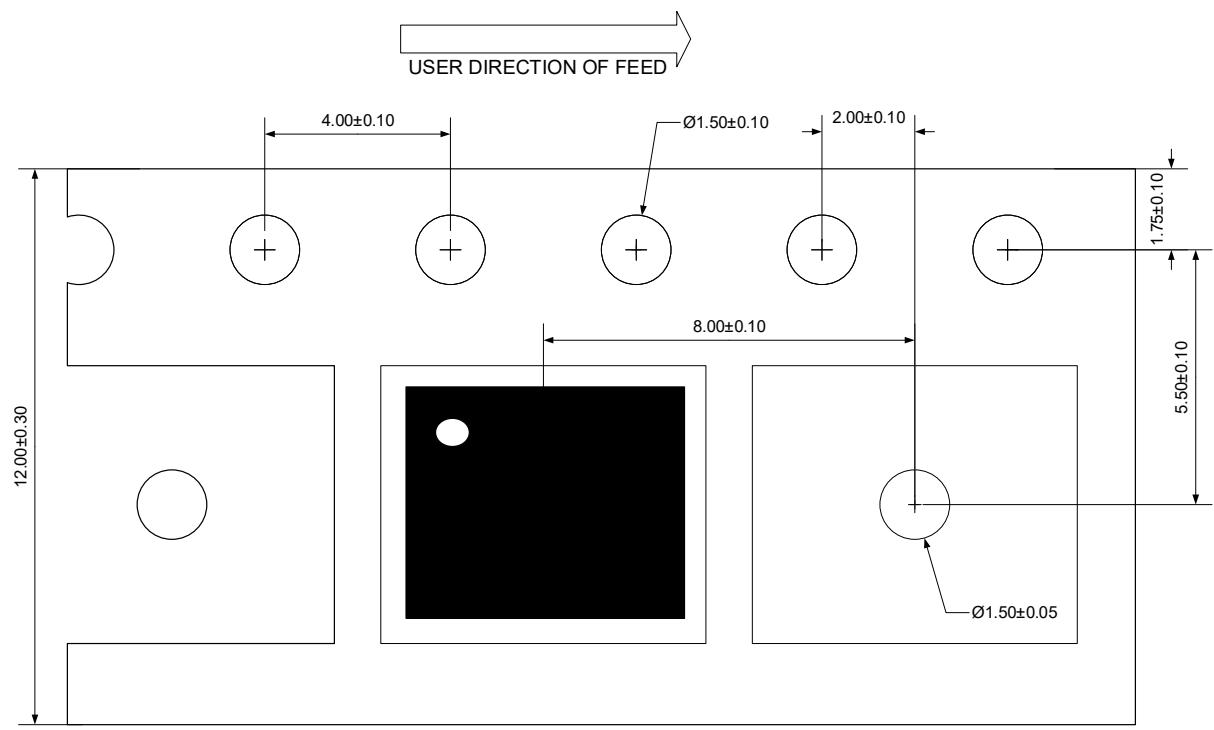
N-Channel MOSFET

PSM8N06R3

Ordering Information

| Device | Package | Reel | Shipping |
|-----------|----------------------|------|--------------------|
| PSM8N06R3 | PDFN5060-8L(Pb-Free) | 13" | 5000 / Tape & Reel |

Load With Information



Unit:mm

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